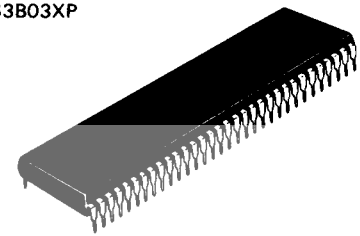
HD6303X, HD63A03X, HD63B03X
CMOS MPU (Micro Processing Unit)

The HD6303X is a CMOS 8-bit micro processing unit (MPU) which includes a CPU compatible with the HD6301V1, 192 bytes of RAM, 24 parallel I/O pins, a Serial Communication Interface (SCI) and two timers on chip.

HD6303XP, HD63A03XP, HD63B03XP

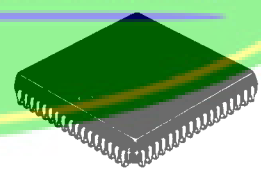


(DP-64S)

HD6303XF, HD63A03XF, HD63B03XF

(FP-80)

HD6303XCP, HD63A03XCP, HD63B03XCP



(CP-68)

■ FEATURES

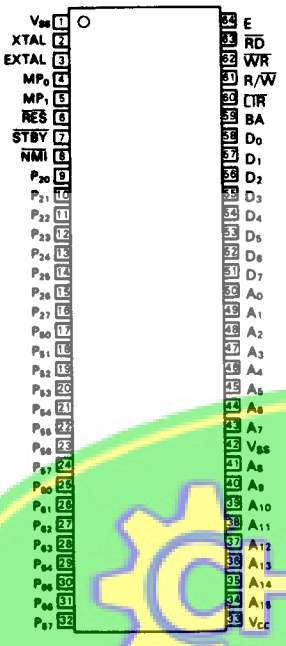
- **Instruction Set Compatible with the HD6301V1**
- 192 Bytes of RAM
- 24 Parallel I/O Pins
  16 I/O Pins-Port 2, 6
  8 Input Pins-Port 5
- Darlington Transistor Drive (Port 2, 6)
- 16-Bit Programmable Timer
  Input Capture Register x 1
  Free Running Counter x 1
  Output Compare Register x 2
- 8-Bit Reloadable Timer
  External Event Counter Square Wave Generation
- Serial Communication Interface
- Memory Ready
- Halt
- Error-Detection (Address Trap, Op-Code Trap)
- Interrupts . . . 3 External, 7 Internal
- Up to 65k Bytes Address Space
- Low Power Dissipation Mode
  Sleep Mode
  Standby Mode
- Minimum Instruction Execution Time -0.5μs (f = 2.0 MHz)
- Wide Range of Operation
  V_{CC} = 3 ~ 6V (f = 0.1 ~ 0.5 MHz),
  V_{CC} = 5V±10% { f = 0.1 ~ 1.0 MHz; HD6303X; f = 0.1 ~ 1.5 MHz; HD63A03X; f = 0.1 ~ 2.0 MHz; HD63B03X

■ PROGRAM DEVELOPMENT SUPPORT TOOLS

- Cross assembler and C compiler software for IBM PCs and compatibles
- In circuit emulator for use with IBM PCs and compatibles

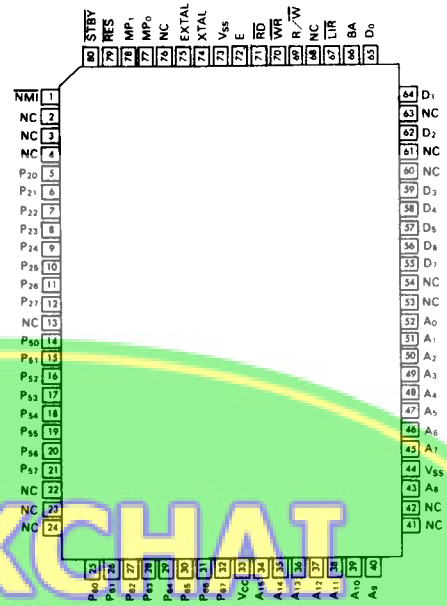
● PIN ARRANGEMENT

● HD6303XP,HD63A03XP,HD63B03XP



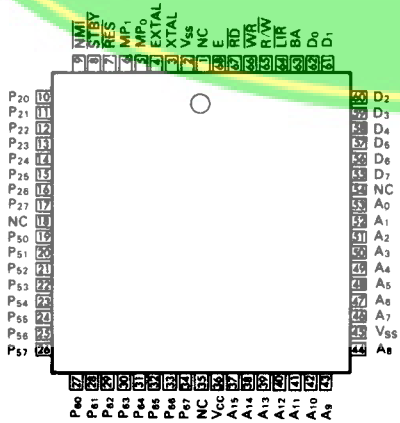
(Top View)

● HD6303XF,HD63A03XF,HD63B03XF



(Top View)

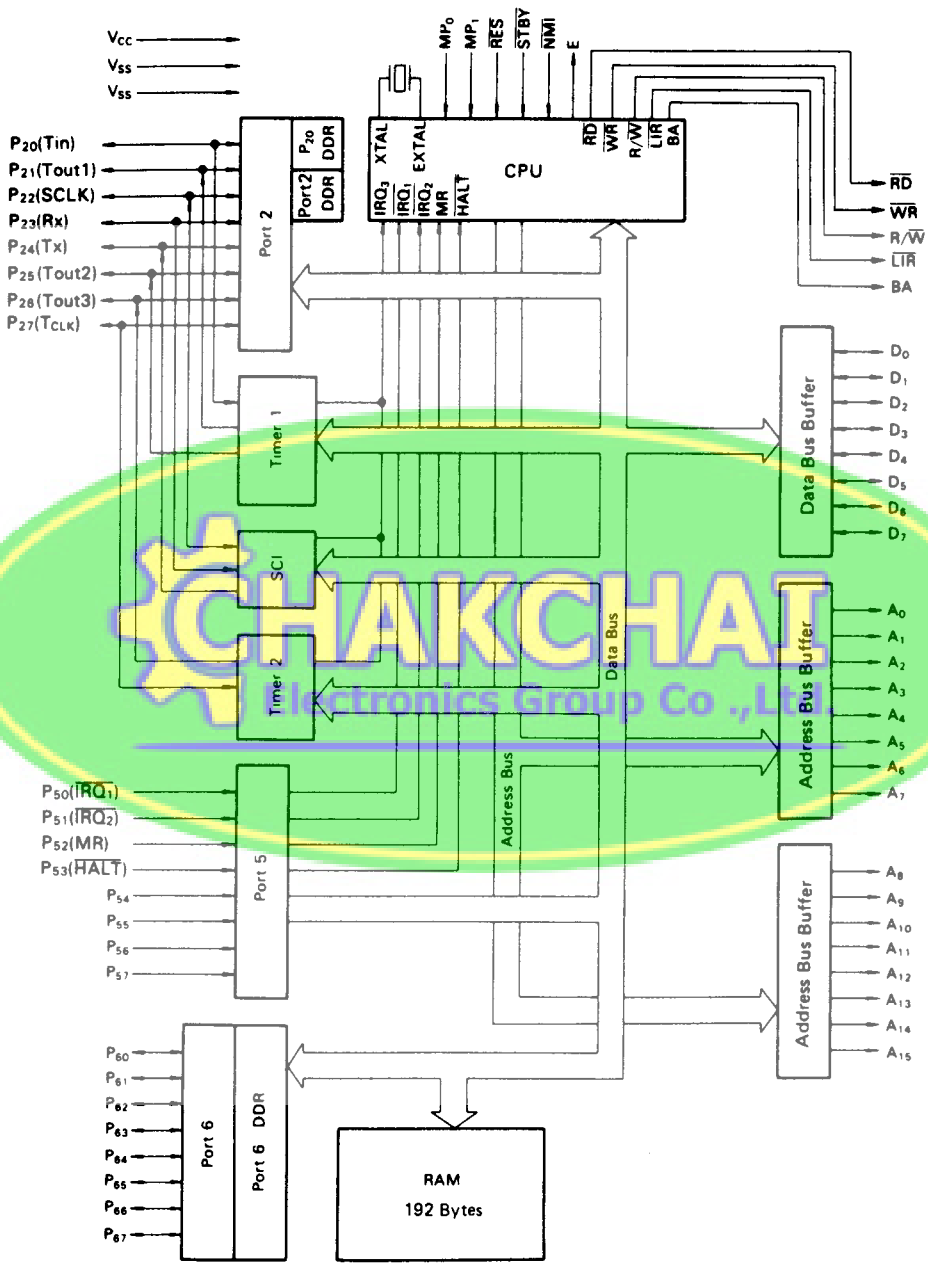
● HD6303XCP,HD63A03XCP,HD63B03XCP



(Top View)

2

■ **BLOCK DIAGRAM**



■ ABSOLUTE MAXIMUM RATINGS

Item	Symbol	Value	Unit
Supply Voltage	V_{CC}	-0.3 ~ +7.0	V
Input Voltage	V_{in}	-0.3 ~ V_{CC}+0.3	V
Operating Temperature	T_{opr}	0 ~ +70	°C
Storage Temperature	T_{stg}	-55 ~ +150	°C

(NOTE) This product has protection circuits in input terminal from high static electricity voltage and high electric field. But be careful not to apply overvoltage more than maximum ratings to these high input impedance protection circuits. To assure the normal operation, we recommend V_{in}, V_{out}: $V_{SS} \leqq (V_{in}$ or $V_{out}) \leqq V_{CC}$.

■ ELECTRICAL CHARACTERISTICS

● DC CHARACTERISTICS (V_{CC} = 5.0V±10%, V_{SS} = 0V, Ta = 0 ~ +70°C, unless otherwise noted.)

Item		Symbol	Test Condition	min	typ	max	Unit
Input "High" Voltage	$\overline{RES}$, $\overline{STBY}$	V_{IH}		V_{CC}-0.5	–	V_{CC} +0.3	V
	EXTAL			V_{CC}x0.7	–		
	Other Inputs			2.0	–		
Input "Low" Voltage	All Inputs	V_{IL}		-0.3	–	0.8	V
Input Leakage Current	$\overline{NMI}$, $\overline{RES}$, $\overline{STBY}$, MP_0, MP_1, Port 5	$\|I_{in}\|$	V_{in} = 0.5 ~ V_{CC}-0.5V	–	–	1.0	μA
Three State (off-state) Leakage Current	A_0~A_{15}, D_0~D_7, $\overline{RD}$, $\overline{WR}$, R/$\overline{W}$, Port 2, Port 6	$\|I_{TSI}\|$	V_{in} = 0.5 ~ V_{CC}-0.5V	–	–	1.0	μA
Output "High" Voltage	All Outputs	V_{OH}	I_{OH} = -200μA	2.4	–	–	V
			I_{OH} = -10μA	V_{CC}-0.7	–	–	V
Output "Low" Voltage	All Outputs	V_{OL}	I_{OL} = 1.6mA	–	–	0.4	V
Darlington Drive Current	Ports 2, 6	$-I_{OH}$	Vout = 1.5V	1.0	–	10.0	mA
Input Capacitance	All Inputs	C_{in}	V_{in} = 0V, f = 1MHz, Ta = 25°C	–	–	12.5	pF
Standby Current	Non Operation	I_{STB}		–	3.0	15.0	μA
Current Dissipation*		I_{SLP}	Sleeping (f = 1MHz**)	–	1.5	3.0	mA
			Sleeping (f = 1.5MHz**)	–	2.3	4.5	mA
			Sleeping (f = 2MHz**)	–	3.0	6.0	mA
		I_{CC}	Operating (f = 1MHz**)	–	7.0	10.0	mA
			Operating (f = 1.5MHz**)	–	10.5	15.0	mA
			Operating (f = 2MHz**)	–	14.0	20.0	mA
RAM Standby Voltage		V_{RAM}		2.0	–	–	V

* V_{IH} min = V_{CC}-1.0V, V_{IL} max = 0.8V , All output terminals are at no load.

** Current Dissipation of the operating or sleeping condition is proportional to the operating frequency. So the typ. or max. values about Current Dissipations at x MHz operation are decided according to the following formula;

typ. value (f = x MHz) = typ. value (f = 1MHz) x x
max. value (f = x MHz) = max. value (f = 1MHz) x x
(both the sleeping and operating)

2

- **AC CHARACTERISTICS** (V_{CC} = 5.0V±10%, V_{SS} = 0V, T_a = 0 ~ +70°C, unless otherwise noted.)

BUS TIMING

Item		Symbol	Test Condition	HD6303X			HD63A03X			HD63B03X			Unit
				min	typ	max	min	typ	max	min	typ	max	
Cycle Time		t_{cyc}	Fig. 1	1	–	10	0.666	–	10	0.5	–	10	µs
Enable Rise Time		t_{Er}		–	–	25	–	–	25	–	–	25	ns
Enable Fall Time		t_{Ef}		–	–	25	–	–	25	–	–	25	ns
Enable Pulse Width "High" Level*		PW_{EH}		450	–	–	300	–	–	220	–	–	ns
Enable Pulse Width "Low" Level*		PW_{EL}		450	–	–	300	–	–	220	–	–	ns
Address, R/$\overline{W}$ Delay Time*		t_{AD}		–	–	250	–	–	190	–	–	160	ns
Data Delay Time	Write	t_{DDW}		–	–	200	–	–	160	–	–	120	ns
Data Set-up Time	Read	t_{DSR}		80	–	–	70	–	–	70	–	–	ns
Address, R/$\overline{W}$ Hold Time*		t_{AH}		80	–	–	50	–	–	35	–	–	ns
Data Hold Time	Write*	t_{HW}		80	–	–	50	–	–	40	–	–	ns
	Read	t_{HR}		0	–	–	0	–	–	0	–	–	ns
$\overline{RD}$, $\overline{WR}$ Pulse Width*		PW_{RW}		450	–	–	300	–	–	220	–	–	ns
$\overline{RD}$, $\overline{WR}$ Delay Time		t_{RWD}		–	–	40	–	–	40	–	–	40	ns
$\overline{RD}$, $\overline{WR}$ Hold Time		t_{HRW}		–	–	30	–	–	30	–	–	25	ns
$\overline{LIR}$ Delay Time		t_{DLR}		–	–	200	–	–	160	–	–	120	ns
$\overline{LIR}$ Hold Time		t_{HLR}		10	–	–	10	–	–	10	–	–	ns
MR Set-up Time*		t_{SMR}	Fig. 2	400	–	–	280	–	–	230	–	–	ns
MR Hold Time*		t_{HMR}		–	–	90	–	–	40	–	–	0	ns
E Clock Pulse Width at MR		PW_{EMR}		–	–	9	–	–	9	–	–	9	µs
Processor Control Set-up Time		t_{PCS}	Fig. 3, 10, 11	200	–	–	200	–	–	200	–	–	ns
Processor Control Rise Time		t_{PCr}	Fig. 2, 3	–	–	100	–	–	100	–	–	100	ns
Processor Control Fall Time		t_{PCf}		–	–	100	–	–	100	–	–	100	ns
BA Delay Time		t_{BA}	Fig. 3	–	–	250	–	–	190	–	–	160	ns
Oscillator Stabilization Time		t_{RC}	Fig. 11	20	–	–	20	–	–	20	–	–	ms
Reset Pulse Width		PW_{RST}		3	–	–	3	–	–	3	–	–	t_{cyc}

* These timings change in approximate proportion to t_{cyc}. The figures in this characteristics represent those when t_{cyc} is minimum (= in the highest speed operation).

PERIPHERAL PORT TIMING

Item		Symbol	Test Condition	HD6303X			HD63A03X			HD63B03X			Unit
				min	typ	max	min	typ	max	min	typ	max	
Peripheral Data Set-up Time	Ports 2, 5, 6	t_{PDSU}	Fig. 5	200	–	–	200	–	–	200	–	–	ns
Peripheral Data Hold Time	Ports 2, 5, 6	t_{PDH}	Fig. 5	200	–	–	200	–	–	200	–	–	ns
Delay Time (Enable Negative Transition to Peripheral Data Valid)	Ports 2, 6	t_{PWD}	Fig. 6	–	–	300	–	–	300	–	–	300	ns